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R8C/33T Group RENESAS MCU

REJ03B0311-0100 Rev.1.00 Mar 16, 2010

1. Overview

1.1 Features

The R8C/33T Group of single-chip MCUs incorporates the R8C CPU core, employing sophisticated instructions for a high level of efficiency. With 1 Mbyte of address space, and it is capable of executing instructions at high speed. In addition, the CPU core boasts a multiplier for high-speed operation processing.

Power consumption is low, and the supported operating modes allow additional power control. These MCUs are designed to maximize EMI/EMS performance.

Integration of many peripheral functions, including multifunction timer and serial interface, reduces the number of system components.

The R8C/33T Group has data flash (1 KB × 4 blocks) with the background operation (BGO) function.

1.1.1 Applications

Electronic household appliances, office equipment, audio equipment, consumer equipment, etc.

1.1.2 Specifications

Tables 1.1 and 1.2 outline the Specifications for R8C/33T Group.

Table 1.1 Specifications for R8C/33T Group (1)

Item	Function	Specification
CPU	Central processing unit	R8C CPU core • Number of fundamental instructions: 89 • Minimum instruction execution time: 50 ns (f(XIN) = 20 MHz, VCC = 2.7 V to 5.5 V) 200 ns (f(XIN) = 5 MHz, VCC = 1.8 V to 5.5 V) • Multiplier: 16 bits × 16 bits → 32 bits • Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits • Operation mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM, Data flash	Refer to Table 1.3 Product List for R8C/33T Group.
Power Supply Voltage Detection	Voltage detection circuit	 Power-on reset Voltage detection 3 (detection level of voltage detection 0 and voltage detection 1 selectable)
I/O Ports	Programmable I/O ports	Input-only: 1 pin CMOS I/O ports: 27, selectable pull-up resistor High current drive ports: 27
Clock	Clock generation circuits	 3 circuits: XIN clock oscillation circuit, High-speed on-chip oscillator (with frequency adjustment function), Low-speed on-chip oscillator Oscillation stop detection: XIN clock oscillation stop detection function Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16 Low power consumption modes: Standard operating mode (high-speed clock, high-speed on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode
Interrupts		 Number of interrupt vectors: 69 External Interrupt: 7 (INT × 4, Key input × 4) Priority levels: 7 levels
Watchdog Tim	er	14 bits x 1 (with prescaler) Reset start selectable Low-speed on-chip oscillator for watchdog timer selectable
DTC (Data Tra	nsfer Controller)	1 channel Activation sources: 22 Transfer modes: 2 (normal mode, repeat mode)
Timer	Timer RA	8 bits x 1 (with 8-bit prescaler) Timer mode (period timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode
	Timer RB	8 bits x 1 (with 8-bit prescaler) Timer mode (period timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode
	Timer RC	16 bits × 1 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode (output 3 pins), PWM2 mode (PWM output pin)

Table 1.2 Specifications for R8C/33T Group (2)

Item	Function	Specification
Serial	UART0, UART1	Clock synchronous serial I/O/UART × 2 channel
Interface	UART2	Clock synchronous serial I/O/UART, I ² C mode (I ² C-bus), SSU mode, multiprocessor communication function
LIN Module		Hardware LIN: 1 (timer RA, UART0)
A/D Converter		10-bit resolution x 12 channels, includes sample and hold function, with sweep mode
Sensor Contro	l Unit	System CH x 3, electrostatic capacitive touch detection x 18
Flash Memory		Programming and erasure voltage: VCC = 2.7 V to 5.5 V Programming and erasure endurance: 10,000 times (data flash) 1,000 times (program ROM) Program security: ROM code protect, ID code check Debug functions: On-chip debug, on-board flash rewrite function Background operation (BGO) function
Operating Fred Voltage	quency/Supply	f(XIN) = 20 MHz (VCC = 2.7 V to 5.5 V) f(XIN) = 5 MHz (VCC = 1.8 V to 5.5 V)
Current Consu	mption	Typ. 6.5 mA (VCC = 5.0 V, f(XIN) = 20 MHz) Typ. 3.5 mA (VCC = 3.0 V, f(XIN) = 10 MHz) Typ. 3.5 μ A (VCC = 3.0 V, wait mode) Typ. 2.0 μ A (VCC = 3.0 V, stop mode)
Operating Amb	pient Temperature	-20 to 85°C (N version) -40 to 85°C (D version) ⁽¹⁾
Package		32-pin LQFP Package code: PLQP0032GB-A (previous code: 32P6U-A)

^{1.} Specify the D version if D version functions are to be used.

1.2 Product List

Table 1.3 lists Product List for R8C/33T Group. Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/33T Group.

Table 1.3 Product List for R8C/33T Group

Current of Mar. 2010

Part No.		apacity	RAM	Package Type	Remarks
r arrivo.	Program ROM	Data flash	Capacity	r donago Typo	rtomanto
R5F21334TNFP	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0032GB-A	N version
R5F21335TNFP	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0032GB-A	
R5F21336TNFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0032GB-A	
R5F21334TDFP	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0032GB-A	D version
R5F21335TDFP	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0032GB-A	
R5F21336TDFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0032GB-A	
R5F21334TNXXXFP (D)	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0032GB-A	N version
R5F21335TNXXXFP (D)	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0032GB-A	Factory-
R5F21336TNXXXFP (D)	32 Kbytes	1 Kbyte x 4	2.5 Kbytes	PLQP0032GB-A	programming product
R5F21334TDXXXFP (D)	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0032GB-A	D version
R5F21335TDXXXFP (D)	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0032GB-A	Factory-
R5F21336TDXXXFP (D)	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0032GB-A	programming product

(D): Under development

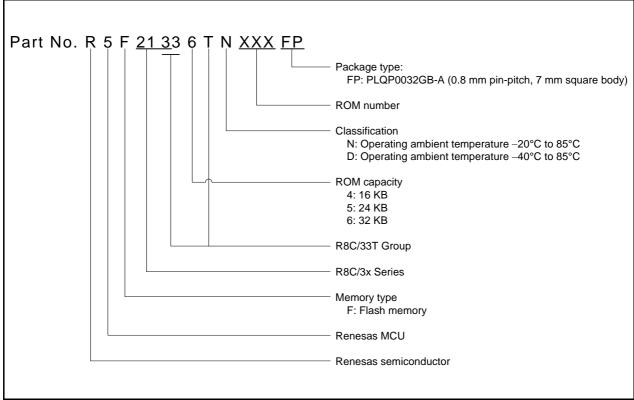


Figure 1.1 Part Number, Memory Size, and Package of R8C/33T Group

1.3 Block Diagram

Figure 1.2 shows a Block Diagram.

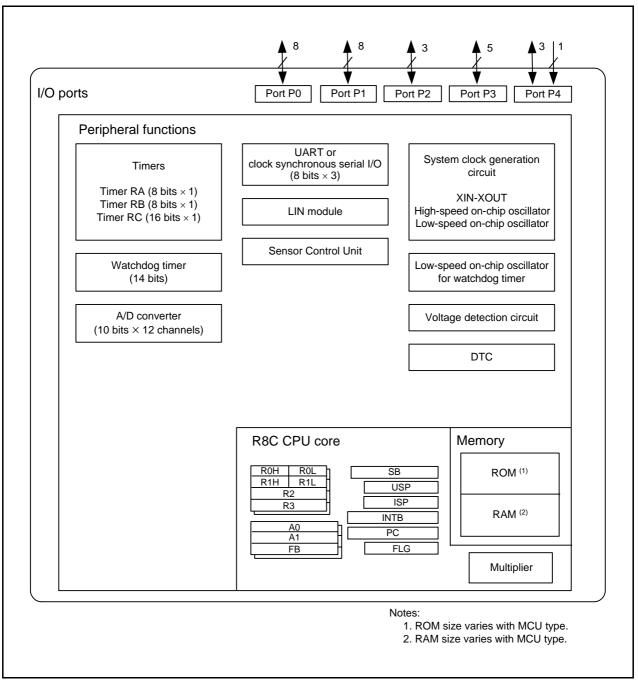


Figure 1.2 Block Diagram

1.4 Pin Assignment

Figure 1.3 shows Pin Assignment (Top View). Table 1.4 outlines the Pin Name Information by Pin Number.

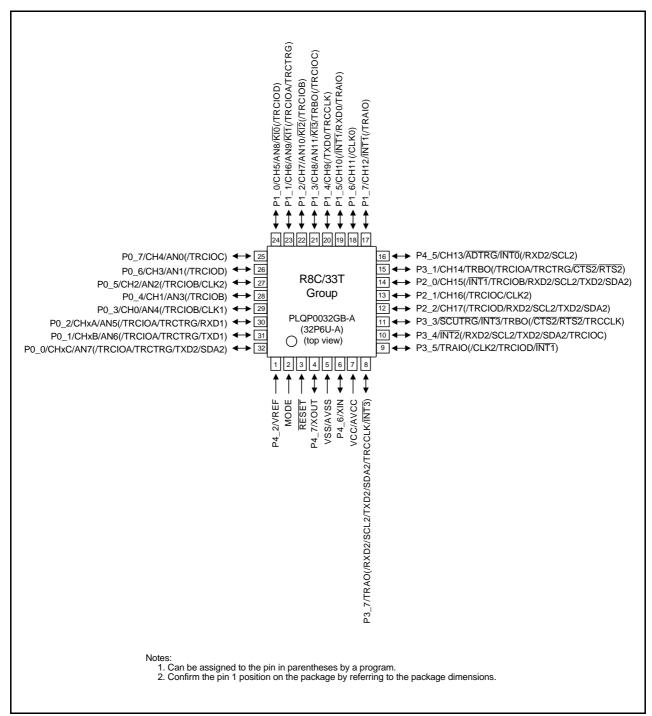


Figure 1.3 Pin Assignment (Top View)

Table 1.4 Pin Name Information by Pin Number

Pin				I/O P	in Functions for Pe	ripheral Modules	
Number	Control Pin	Port	Interrupt	Timer	Serial Interface	A/D Converter	Sensor Control Unit
1		P4_2				VREF	
2	MODE						
3	RESET						
4	XOUT	P4_7					
5	VSS/AVSS						
6	XIN	P4_6					
7	VCC/AVCC						
8		P3_7	(INT3)	TRAO/ (TRCCLK)	(RXD2/SCL2/ TXD2/SDA2)		
9		P3_5	(INT1)	TRAIO/ (TRCIOD)	(CLK2)		
10		P3_4	ĪNT2	(TRCIOC)	(RXD2/SCL2/ TXD2/SDA2)		
11		P3_3	ĪNT3	TRBO/ (TRCCLK)	(CTS2/RTS2)		SCUTRG
12		P2_2		(TRCIOD)	(RXD2/TXD2/ SCL2/SDA2)		CH17
13		P2_1		(TRCIOC)	(CLK2)		CH16
14		P2_0	(INT1)	(TRCIOB)	(RXD2/TXD2/ SCL2/SDA2)		CH15
15		P3_1		TRBO/ (TRCTRG/ TRCIOA)	(CTS2/RTS2)		CH14
16		P4_5	ĪNT0	<u> </u>	(RXD2/SCL2)	ADTRG	CH13
17		P1_7	INT1	(TRAIO)			CH12
18		P1_6			(CLK0)		CH11
19		P1_5	(INT1)	(TRAIO)	(RXD0)		CH10
20		P1_4	· /	(TRCCLK)	(TXD0)		CH9
21		P1_3	KI3	TRBO (/TRCIOC)		AN11	CH8
22		P1_2	KI2	(TRCIOB)		AN10	CH7
23		P1_1	KI1	(TRCIOA/ TRCTRG)		AN9	CH6
24		P1_0	KI0	(TRCIOD)		AN8	CH5
25		P0_7		(TRCIOC)		AN0	CH4
26		P0_6		(TRCIOD)		AN1	CH3
27		P0_5		(TRCIOB)	(CLK2)	AN2	CH2
28		P0_4		(TRCIOB)		AN3	CH1
29		P0_3		(TRCIOB)	(CLK1)	AN4	CH0
30		P0_2		(TRCIOA/ TRCTRG)	(RXD1)	AN5	CHxA
31		P0_1		(TRCIOA/ TRCTRG)	(TXD1)	AN6	СНхВ
32		P0_0		(TRCIOA/ TRCTRG)	(TXD2/SDA2)	AN7	CHxC

^{1.} Can be assigned to the pin in parentheses by a program.

1.5 Pin Functions

Table 1.5 lists Pin Functions.

Table 1.5 Pin Functions

Item	Pin Name	I/O Type	Description
Power supply input	VCC, VSS	_	Apply 1.8 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	_	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	RESET	I	Input "L" on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins. (1)
XIN clock output	XOUT	I/O	To use an external clock, input it to the XOUT pin and leave the XIN pin open.
INT interrupt input	INTO to INT3	I	INT interrupt input pins. INT0 is timer RB, and RC input pin.
Key input interrupt	KI0 to KI3	I	Key input interrupt input pins
Timer RA	TRAIO	I/O	Timer RA I/O pin
	TRAO	0	Timer RA output pin
Timer RB	TRBO	0	Timer RB output pin
Timer RC	TRCCLK	I	External clock input pin
	TRCTRG	I	External trigger input pin
	TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Timer RC I/O pins
Serial interface	CLK0, CLK1, CLK2	I/O	Transfer clock I/O pins
	RXD0, RXD1, RXD2	I	Serial data input pins
	TXD0, TXD1, TXD2	0	Serial data output pins
	CTS2	I	Transmission control input pin
	RTS2	0	Reception control output pin
	SCL2	I/O	I ² C mode clock I/O pin
	SDA2	I/O	I ² C mode data I/O pin
Reference voltage input	VREF	I	Reference voltage input pin to A/D converter
A/D converter	AN0 to AN11	I	Analog input pins to A/D converter
	ADTRG	I	AD external trigger input pin
Sensor control unit	CHxA, CHxB, CHxC	I/O	Control pins for electrostatic capacitive touch detection
	CH0 to CH17	I	Electrostatic capacitive touch detection pins
	SCUTRG	I	Sensor control unit external trigger input
I/O port	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_2, P3_1, P3_3 to P3_5, P3_7, P4_5 to P4_7	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. All ports can be used as LED drive ports.
Input port	P4_2	I	Input-only port

I: Input

O: Output

I/O: Input and output

Note:

1. Refer to the oscillator manufacturer for oscillation characteristics.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

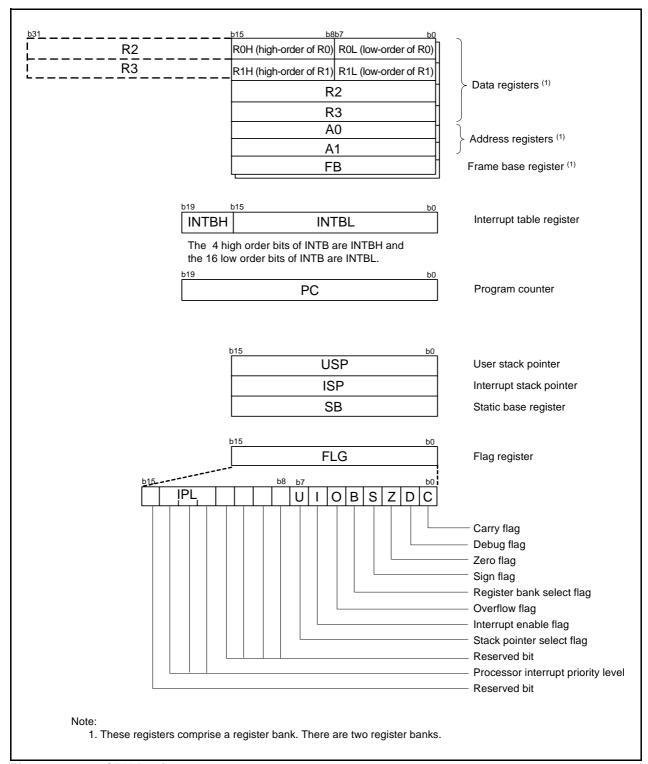


Figure 2.1 CPU Registers

2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 and as a 32bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 **Interrupt Table Register (INTB)**

INTB is a 20-bit register that indicates the starting address of an interrupt vector table.

2.5 **Program Counter (PC)**

PC is 20 bits wide and indicates the address of the next instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0.

2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9 **Processor Interrupt Priority Level (IPL)**

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has higher priority than IPL, the interrupt is enabled.

2.8.10 **Reserved Bit**

If necessary, set to 0. When read, the content is undefined.

R8C/33T Group 3. Memory

3. Memory

3.1 R8C/33T Group

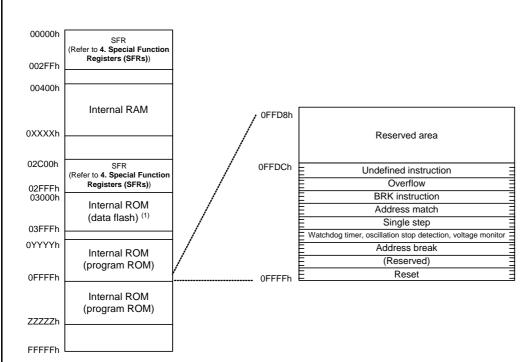
Figure 3.1 is a Memory Map of R8C/33T Group. The R8C/33T Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 32-Kbyte internal ROM area is allocated addresses 08000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. The starting address of each interrupt routine is stored here.

The internal ROM (data flash) is allocated addresses 03000h to 03FFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM area is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh and 02C00h to 02FFFh. Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.



- 1. Data flash indicates block A (1 Kbyte), block B (1 Kbyte), block C (1 Kbyte), and block D (1 Kbyte).
- 2. The blank areas are reserved and cannot be accessed by users.

Part Number		Internal ROM		Inte	ernal RAM
Fait Number	Size	Address 0YYYYh	Address ZZZZZh	Size	Address 0XXXXh
R5F21334TNFP, R5F21334TDFP,	16 Kbytes	0C000h		1.5 Kbytes	009FFh
R5F21334TNXXXFP, R5F21334TDXXXFP	16 Kbytes	0000011	_	1.5 Kbytes	009FFII
R5F21335TNFP, R5F21335TDFP,	24 Kbytes	0A000h		2 Kbytes	00BFFh
R5F21335TNXXXFP, R5F21335TDXXXFP	24 Noyles	OAOOOII	_	Z Noytes	OODITII
R5F21336TNFP, R5F21336TDFP,	32 Kbytes	08000h	_	2.5 Kbytes	00DFFh
R5F21336TNXXXFP, R5F21336TDXXXFP	32 Noyles	0000011		2.5 Kbyles	OODFFII

Figure 3.1 Memory Map of R8C/33T Group

4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.12 list the special function registers. Table 4.13 lists the ID Code Areas and Option Function Select Area.

Table 4.1 SFR Information (1) (1)

Address	Register	Symbol	After Reset
0000h	Register	Gymbol	Allei Reget
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PMO	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CMO	00101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h	Module Standby Control Register	MSTCR	00h
0009h	System Clock Control Register 3	CM3	00h
000Ah	Protect Register	PRCR	00h
000Bh	Reset Source Determination Register	RSTFR	0XXXXXXXb (2)
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Negister Watchdog Timer Start Register	WDTS	XXh
000En	Watchdog Timer Control Register	WDTC	00111111b
000111 0010h	Watchdog Timer Control Register	WBIC	0011111111
0010h			
0011h			
0012h			
0013h			
0014H	High-Speed On-Chip Oscillator Control Register 7	FRA7	When shipping
0015h	Thigh opera off-only oscillator control register /	I NA/	when shipping
0010h			
0017h			
0019h			
0013h			
0017th			
001Ch	Count Source Protection Mode Register	CSPR	00h
001011	Godin Godios i Totostion Mode Rogistor	00111	10000000b (3)
001Dh			100000000 (9)
001Eh			
001En			
001111 0020h			
0020h			
002111 0022h			
0022h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0023H 0024h	High-Speed On-Chip Oscillator Control Register 1	FRA0	When shipping
0024H	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0025H	On-Chip Reference Voltage Control Register	OCVREFCR	00h
002011 0027h	On-Chip Reference Voltage Control Register	OCVRETCR	0011
002711 0028h	Clock Prescaler Reset Flag	CPSRF	00h
0020h	High-Speed On-Chip Oscillator Control Register 4	FRA4	When shipping
0029h	High-Speed On-Chip Oscillator Control Register 5	FRA5	When shipping
002An	High-Speed On-Chip Oscillator Control Register 6	FRA6	When shipping
002BH	Thigh opera off-only oscillator control register o	I NAU	wilen shipping
002Ch			
002Dh			
002En	High-Speed On-Chip Oscillator Control Register 3	FRA3	When shipping
		CMPA	
0030h 0031h	Voltage Monitor Circuit Control Register Voltage Monitor Circuit Edge Select Register	VCAC	00h 00h
0031h	vollage Monitor Official Lage Gelect Neglister	VOAC	0011
0032h	Voltage Detect Register 1	VCA1	00001000b
0033h	Voltage Detect Register 1 Voltage Detect Register 2	VCA1	0000 1000B
003411	vollage Delect Negislei Z	VCAZ	
0007			00100000b ⁽⁵⁾
0035h		\/22	
0036h	Voltage Detection 1 Level Select Register	VD1LS	00000111b
0037h		,	
0038h	Voltage Monitor 0 Circuit Control Register	VW0C	1100X010b (4)
	Voltage Monitor 1 Circuit Control Register	VW1C	1100X011b ⁽⁵⁾ 10001010b

X: Undefined

- 1. The blank areas are reserved and cannot be accessed by users.
- 2. The CWR bit in the RSTFR register is set to 0 after power-on and voltage monitor 0 reset. Hardware reset, Software reset, or watchdog timer reset does not affect this bit.
- 3. The CSPROINI bit in the OFS register is set to 0.
- 4. The LVDAS bit in the OFS register is set to 1.
- 5. The LVDAS bit in the OFS register is set to 0.

SFR Information (2) (1) Table 4.2

Address	Register	Symbol	After Reset
003Ah	Voltage Monitor 2 Circuit Control Register	VW2C	10000010b
003Bh			
003Ch			
003Dh			
003Eh			
003Fh			
0040h			
0041h	Flash Memory Ready Interrupt Control Register	FMRDYIC	XXXXX000b
0041h	Trash Memory Ready Interrupt Control Register	TWINDTIO	70000000
0042h			
0044h			
0045h			
0046h			
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0048h			
0049h			
004Ah			
004Bh	UART2 Transmit Interrupt Control Register	S2TIC	XXXXX000b
004Ch	UART2 Receive Interrupt Control Register	S2RIC	XXXXX000b
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004En	7.22 Sam Stollar Interrupt Control Register	, 1510	707070000
004Fn 0050h			
	LIADTO Transmit Interrupt Control Descietas	COTIO	VVVVV
0051h	UARTO Transmit Interrupt Control Register	SOTIC	XXXXX000b
0052h	UARTO Receive Interrupt Control Register	SORIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005An	11413 Interrupt Control Negister	1141316	AAOOAOOOD
005Ch	INITE LA COLLA DE	IN ITOLO	V(/20V/2001
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh	UART2 Bus Collision Detection Interrupt Control Register	U2BCNIC	XXXXX000b
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h		+	
0066h			
0067h			
0068h			
0069h			
006Ah	Sensor Control Unit Interrupt Control Register	SCUIC	XXXXX000b
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			<u> </u>
0070H			+
0071h	Voltage Manitor 1 Interrupt Control Desister	VOMPAIO	VVVVV000h
	Voltage Monitor 1 Interrupt Control Register Voltage Monitor 2 Interrupt Control Register	VCMP1IC	XXXXX000b
0073h	voltage infolitor z interrupt Control Register	VCMP2IC	XXXXX000b
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
0079h 007Ah			
007Ah			
007Ah 007Bh			
007Ah 007Bh 007Ch			
007Ah 007Bh 007Ch 007Dh			
007Ah 007Bh 007Ch			

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.3 SFR Information (3) (1)

Address	Pogistor	Symbol	After Reset
0080h	Register DTC Activation Control Register	DTCTL	00h
0080h	DTC Activation Control Register	DICIL	0011
0081h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h	DTC Activation Enable Register 0	DTCEN0	00h
0089h	DTC Activation Enable Register 1	DTCEN1	00h
008Ah	DTC Activation Enable Register 2	DTCEN2	00h
008Bh	DTC Activation Enable Register 3	DTCEN3	00h
008Ch			
008Dh	DTC Activation Enable Register 5	DTCEN5	00h
008Eh	DTC Activation Enable Register 6	DTCEN6	00h
008Fh	0		
0090h			
0091h			
0092h		+	1
0092h			
0093H			
0094h		<u> </u>	
0096h			
0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UART0 Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h	_		XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00/ton	O/IKTO Receive Bullet Register	COND	XXh
00A711	UART2 Transmit/Receive Mode Register	U2MR	00h
		U2BRG	XXh
00A9h	UART2 Bit Rate Register		
00AAh	UART2 Transmit Buffer Register	U2TB	XXh
00ABh	HARTOT W/D : O	11222	XXh
00ACh	UART2 Transmit/Receive Control Register 0	U2C0	00001000b
00ADh	UART2 Transmit/Receive Control Register 1	U2C1	00000010b
00AEh	UART2 Receive Buffer Register	U2RB	XXh
00AFh			XXh
00B0h	UART2 Digital Filter Function Select Register	URXDF	00h
00B1h			
00B2h			
00B3h			
00B4h			
00B5h			
00B6h			
00B7h			1
00B8h			
00B9h		+	<u> </u>
00BAh			
00BAI1	UART2 Special Mode Register 5	U2SMR5	00h
00BCh	UART2 Special Mode Register 5 UART2 Special Mode Register 4		ı
LILIES L.D.		U2SMR4	00h 000X0X0Xb
	LIADTO Cassial Made Desister C		
00BDh	UART2 Special Mode Register 3	U2SMR3	
	UART2 Special Mode Register 3 UART2 Special Mode Register 2 UART2 Special Mode Register	U2SMR3 U2SMR2 U2SMR	X0000000b X0000000b

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.4 SFR Information (4) (1)

Λ ol al ::	Dominton.	0	A440-D4
Address	Register	Symbol	After Reset
00C0h	A/D Register 0	AD0	XXh
00C1h			000000XXb
00C2h	A/D Register 1	AD1	XXh
00C3h			000000XXb
00C4h	A/D Register 2	AD2	XXh
00C5h	1		000000XXb
00C6h	A/D Register 3	AD3	XXh
00C7h	- Noglotor o	7.20	000000XXb
00C8h	A/D Register 4	AD4	XXh
	AVD Register 4	AD4	
00C9h	1 A/D D 1 / -		000000XXb
00CAh	A/D Register 5	AD5	XXh
00CBh			000000XXb
00CCh	A/D Register 6	AD6	XXh
00CDh			000000XXb
00CEh	A/D Register 7	AD7	XXh
00CFh			000000XXb
00D0h			
00D1h			
00D2h			
00D3h			
00D3fi 00D4h	A/D Mode Register	ADMOD	00h
	A/D Mode Register		00h
00D5h	A/D Input Select Register	ADINSEL	11000000b
00D6h	A/D Control Register 0	ADCON0	00h
00D7h	A/D Control Register 1	ADCON1	00h
00D8h			
00D9h			
00DAh			
00DBh			
00DCh			
00DDh		+	
00DBh			
00DEII			
	D (D0 D)	D0	200
00E0h	Port P0 Register	P0	XXh
00E1h	Port P1 Register	P1	XXh
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h	Port P2 Register	P2	XXh
00E5h	Port P3 Register	P3	XXh
00E6h	Port P2 Direction Register	PD2	00h
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	XXh
00E9h	1 of the register	1 7	70(1)
00EAh	Part D4 Direction Register	PD4	00b
	Port P4 Direction Register	PD4	00h
00EBh			
00ECh			
00EDh			
00EEh			
00EFh			
00F0h			
00F1h			
00F2h			
00F3h		<u> </u>	
00F4h			
00F5h		-	+
00F6h			
00F7h			
00F8h			
00F8h			
00F8h 00F9h			
00F8h 00F9h 00FAh 00FBh			
00F8h 00F9h 00FAh 00FBh 00FCh			
00F8h 00F9h 00FAh 00FBh 00FCh 00FDh			
00F8h 00F9h 00FAh 00FBh 00FCh			

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.5 SFR Information (5) (1)

Address	Register	Symbol	After Reset
0100h	Timer RA Control Register	TRACR	00h
0100h	Timer RA I/O Control Register	TRAIOC	00h
0101h	Timer RA Mode Register	TRAMR	00h
0102h		TRAPRE	FFh
	Timer RA Prescaler Register		FFh
0104h	Timer RA Register	TRA	
0105h	LIN Control Register 2	LINCR2	00h
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
010Fh			
0110h			
0111h			
0111h			
0112h			
0113h 0114h			
0115h			
0116h			
0117h			
0118h			
0119h			
011Ah			
011Bh			
011Ch			
011Dh			
011Eh			
011Fh			
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0125h	Timer RC Counter	TRC	00h
0120H	Timer NC Counter	INC	00h
	F 000 10 11 4	TDOODA	
0128h	Timer RC General Register A	TRCGRA	FFh
0129h			FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh			FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
012Dh			FFh
012Eh	Timer RC General Register D	TRCGRD	FFh
012Fh			FFh
0130h		TRCCR2	00011000b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0132h	Timer RC Output Master Enable Register	TRCOER	01111111b
0133h	Timer RC Trigger Control Register	TRCADCR	00h
0134h	30 0		
0135h			
0136h			
0137h			
0137H			
0139h			
0139h			
013Bh			
013Ch			
013Dh			
013Eh			
013Fh			

^{1.} The blank areas are reserved and cannot be accessed by users.

Table 4.6 SFR Information (6) (1)

A ddraaa	Pogliston	Cumahal	After Deept
Address	Register	Symbol	After Reset
0140h			
0141h			
0142h			
0143h			
0144h			
0145h			
0146h			
0147h			
0148h			
0149h			
014Ah			
014Bh			
014Ch			
014Dh			
014Eh			
014Fh			
0150h			
0151h			
0152h			
0153h			
0154h			
0155h			
0156h			
0157h			
0158h			
0159h			
015Ah			
015Bh			
015Ch			
015Dh			
015Eh			
015Fh			
0160h	UART1 Transmit/Receive Mode Register	U1MR	00h
	UARTI PILI DE LA PARTICIO DE LA PROPERTICIO DE LA PROPERTICION DELICION DE LA PROPERTICION DE LA PROPERTICION DE LA PROPERTICIO		
0161h	UART1 Bit Rate Register	U1BRG	XXh
0162h	UART1 Transmit Buffer Register	U1TB	XXh
0163h			XXh
04045			///III
U164n	UART1 Transmit/Receive Control Register 0	U1C0	
0164h	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
0165h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b
0165h 0166h	UART1 Transmit/Receive Control Register 0 UART1 Transmit/Receive Control Register 1 UART1 Receive Buffer Register	U1C0 U1C1 U1RB	00001000b 00000010b XXh
0165h 0166h 0167h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b
0165h 0166h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 016Fh	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch 016Ch 016Fh	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Dh 016Fh 0170h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch 016Fh 0170h 0171h 0172h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 0170h 0171h 0172h 0173h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 0170h 0171h 0172h 0173h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 0170h 0171h 0172h 0173h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch 016Fh 0170h 0171h 0172h 0173h 0174h 0175h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 0170h 0171h 0172h 0173h 0174h 0175h 0176h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Bh 016Fh 0170h 0171h 0172h 0173h 0174h 0175h 0176h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Bh 016Fh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0177h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 0170h 0171h 0172h 0173h 0174h 0175h 0176h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch 016Eh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0176h 0176h 0177h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch 016Eh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0176h 0177h 0178h 0179h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 016Ah 016Bh 016Ch 016Ch 016Eh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0177h 0178h 0179h 0179h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0177h 0178h 0179h 0178h 0179h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 0168h 0169h 016Ch 016Ch 016Eh 016Fh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0177h 0178h 0179h 0178h 0179h 0178h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 0169h 016Ah 016Bh 016Ch 016Dh 016Eh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0177h 0178h 0179h 0178h 0179h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh
0165h 0166h 0167h 0168h 0169h 0168h 0169h 016Ch 016Ch 016Eh 016Fh 0170h 0171h 0172h 0173h 0174h 0175h 0176h 0177h 0178h 0179h 0178h 0179h 0178h	UART1 Transmit/Receive Control Register 1	U1C1	00001000b 00000010b XXh

Note

1. The blank areas are reserved and cannot be accessed by users.

Table 4.7 SFR Information (7) (1)

Address	Register	Symbol	After Reset
0180h	Timer RA Pin Select Register	TRASR	00h
0180h	Timer RB/RC Pin Select Register	TRBRCSR	00h
0181h	Timer RC Pin Select Register 0	TRCPSR0	00h
	Timer RC Pin Select Register 0		
0183h	Timer RC Pin Select Register 1	TRCPSR1	00h
0184h			
0185h			
0186h			
0187h			
0188h	UART0 Pin Select Register	U0SR	00h
0189h	UART1 Pin Select Register	U1SR	00h
018Ah	UART2 Pin Select Register 0	U2SR0	00h
018Bh	UART2 Pin Select Register 1	U2SR1	00h
018Ch			
018Dh			
018Eh	INT Interrupt Input Pin Select Register	INTSR	00h
018Fh	I/O Function Pin Select Register	PINSR	00h
0190h	Low-Voltage Signal Mode Control Register	TSMR	00h
0191h			
0192h			
0193h			
0194h		1	
0195h		1	
0196h		1	
019011 0197h		 	
0198h			
0199h			
019Ah			
019An			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh		1	
01ADh			
01AEh			
01AFh			
01B0h			
01B1h		1	
01B1h	Flash Memory Status Register	FST	10000X00b
01B3h	I last monory status register		100000000
01B4h	Flash Memory Control Register 0	FMR0	00h
01B4h	Flash Memory Control Register 0 Flash Memory Control Register 1	FMR1	00h
01B5h	Flash Memory Control Register 1 Flash Memory Control Register 2	FMR2	00h
01B6h 01B7h	riash wemory Control Register 2	FIVIK∠	UUII
01B8h		ļ	
01B9h		1	
01BAh		ļ	
01BBh			
01BCh			
01BDh			
01BEh			
01BFh			
Villadefined			

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.8 SFR Information (8) (1)

Address	Register	Symbol	After Reset
01C0h	Address Match Interrupt Register 0	RMAD0	XXh
01C1h			XXh
01C2h			0000XXXXb
01C3h	Address Match Interrupt Enable Register 0	AIER0	00h
01C4h	Address Match Interrupt Register 1	RMAD1	XXh
01C5h	<u> </u>		XXh
01C6h	†		0000XXXXb
01C7h	Address Match Interrupt Enable Register 1	AIER1	00h
01C8h	Address Mater Interrupt Enable Register 1	AULICI	0011
01C9h			
01C3h			
01CAn			
01CCh			
01CDh			
01CEh			
01CFh			
01D0h			
01D1h			
01D2h			
01D3h			
01D4h			
01D5h			
01D6h			
01D7h			
01D711			
01D0h			
01D3H			
01DBh			
01DCh			
01DDh			
01DEh			
01DFh			
01E0h	Pull-Up Control Register 0	PUR0	00h
01E1h	Pull-Up Control Register 1	PUR1	00h
01E2h			
01E3h			
01E4h			
01E5h			
01E6h			
01E7h			
01E8h			
01E9h			
01EAh			
01EBh			
01ECh			
01EDh			
01EEh			
01EFh			
01F0h	Port P1 Drive Capacity Control Register	P1DRR	00h
01F1h	Port P2 Drive Capacity Control Register	P2DRR	00h
01F2h	Drive Capacity Control Register 0	DRR0	00h
01F3h	Drive Capacity Control Register 1	DRR1	00h
01F4h			
01F5h	Input Threshold Control Register 0	VLT0	00h
01F6h	Input Threshold Control Register 1	VLT1	00h
01F7h	, , , , , , , , , , , , , , , , , , ,		
01F8h			
01F9h	 		
01F9fi 01FAh	External Input Enable Register 0	INTEN	00h
	елентат присенале кеугаег U	INIEN	UUII
01FBh	INT book Files Calast Daviston C	INITE	L COL
01FCh	INT Input Filter Select Register 0	INTF	00h
01FDh			
01FEh	Key Input Enable Register 0	KIEN	00h
01FFh			

Note:

The blank areas are reserved and cannot be accessed by users.

Table 4.9 SFR Information (9) (1)

Address	Register	Symbol	After Reset
02C0h	SCU Control Register 0	SCUCR0	00h
02C1h	SCU Mode Register	SCUMR	00h
02C2h	SCU Timing Control Register 0	SCTCR0	00000011b
02C3h	SCU Timing Control Register 1	SCTCR1	00000001b
02C4h	SCU Timing Control Register 2	SCTCR2	00010000b
02C5h	SCU Timing Control Register 3	SCTCR3	00h
02C6h	SCU Channel Control Register	SCHCR	00h
02C7h	SCU Channel Control Counter	SCUCHC	00h
02C8h	SCU Flag Register	SCUFR	00h
02C9h	SCU Status Counter	SCUSTC	00h
02CAh	SCU Secondary Counter Set Register	SCSCSR	00000111b
02CBh	SCU Secondary Counter	SCUSCC	00000111b
02CCh			
02CDh			
02CEh	SCU Destination Address Register	SCUDAR	00h
02CFh			00001100b
02D0h	SCU Data Buffer Register	SCUDBR	00h
02D1h			00h
02D2h	SCU Primary Counter	SCUPRC	00h
02D3h			00h
02D4h			
02D5h			
02D6h			
02D7h			
02D8h			
02D9h			
02DAh			
02DBh		TOLEDO	
02DCh	Touch Sensor Input Enable Register 0	TSIER0	00h
02DDh	Touch Sensor Input Enable Register 1	TSIER1	00h
02DEh	Touch Sensor Input Enable Register 2	TSIER2	00h
02DFh			
2C00h	I DTC Transfer Vector Area	1	XXh
2C00fi	DTC Transfer Vector Area DTC Transfer Vector Area		XXh
2C0111	DTC Transfer Vector Area		XXh
2C02h	DTC Transfer Vector Area		XXh
2C03h	DTC Transfer Vector Area		XXh
2C05h	DTC Transfer Vector Area		XXh
2C06h	DTC Transfer Vector Area		XXh
2C07h	DTC Transfer Vector Area		XXh
2C08h	DTC Transfer Vector Area		XXh
2C09h	DTC Transfer Vector Area		XXh
2C0Ah	DTC Transfer Vector Area		XXh
:	DTC Transfer Vector Area	I .	XXh
:	DTC Transfer Vector Area		XXh
2C3Ah	DTC Transfer Vector Area		XXh
2C3Bh	DTC Transfer Vector Area		XXh
2C3Ch	DTC Transfer Vector Area		XXh
2C3Dh	DTC Transfer Vector Area		XXh
2C3Eh	DTC Transfer Vector Area		XXh
2C3Fh	DTC Transfer Vector Area		XXh
2C40h	DTC Control Data 0	DTCD0	XXh
2C41h			XXh
2C42h			XXh
2C43h			XXh
2C44h			XXh
2C45h			XXh
2C46h			XXh
2C47h			XXh
2C48h	DTC Control Data 1	DTCD1	XXh
2C49h			XXh
2C4Ah			XXh
2C4Bh			XXh
2C4Ch			XXh
2C4Dh			XXh
2C4Eh			XXh
2C4Fh			XXh

Note:

The blank areas are reserved and cannot be accessed by users.

Table 4.10 SFR Information (10) (1)

	. ,		1 10
Address	Register	Symbol	After Reset
2C50h	DTC Control Data 2	DTCD2	XXh
2C51h			XXh
2C52h]		XXh
2C53h			XXh
2C54h	†		XXh
2C55h	1		XXh
2C56h	-		XXh
2C57h	4		XXh
	DTO Control Data 0	DTODO	
2C58h	DTC Control Data 3	DTCD3	XXh
2C59h			XXh
2C5Ah			XXh
2C5Bh			XXh
2C5Ch]		XXh
2C5Dh			XXh
2C5Eh	†		XXh
2C5Fh	-		XXh
2C60h	DTC Control Data 4	DTCD4	XXh
2C61h	DTC Control Data 4	D10D4	
			XXh
2C62h		1	XXh
2C63h			XXh
2C64h			XXh
2C65h			XXh
2C66h			XXh
2C67h	1		XXh
2C68h	DTC Control Data 5	DTCD5	XXh
2C69h		2.020	XXh
2C6Ah	-		XXh
2C6Bh			XXh
2C6Ch			XXh
2C6Dh			XXh
2C6Eh			XXh
2C6Fh			XXh
2C70h	DTC Control Data 6	DTCD6	XXh
2C71h	1		XXh
2C72h	†		XXh
2C73h	-		XXh
2C74h	-		XXh
2C75h			XXh
2C76h			XXh
2C77h			XXh
2C78h	DTC Control Data 7	DTCD7	XXh
2C79h]		XXh
2C7Ah	1	1	XXh
2C7Bh	1		XXh
2C7Ch	1		XXh
2C7Dh	-		XXh
	-		
2C7Eh	-		XXh
2C7Fh			XXh
2C80h	DTC Control Data 8	DTCD8	XXh
2C81h			XXh
2C82h			XXh
2C83h		1	XXh
2C84h	1		XXh
2C85h	1		XXh
2C86h	1		XXh
2C87h	-	1	XXh
	DTC Control Data 0	DTODO	
2C88h	DTC Control Data 9	DTCD9	XXh
2C89h			XXh
2C8Ah			XXh
2C8Bh			XXh
2C8Ch	1		XXh
2C8Dh	1		XXh
2C8Eh	1		XXh
2C8Fh	1		XXh
200111			AAH

Note:

The blank areas are reserved and cannot be accessed by users.

Table 4.11 SFR Information (11) (1)

Address	Register	Symbol	After Reset
2C90h	DTC Control Data 10	DTCD10	XXh
2C91h			XXh
2C92h			XXh
2C93h			XXh
2C94h			XXh
2C95h			XXh
2C96h	-		XXh
2C97h	4		XXh
	DTO Control Date 44	DT0D44	
2C98h	DTC Control Data 11	DTCD11	XXh
2C99h			XXh
2C9Ah			XXh
2C9Bh			XXh
2C9Ch			XXh
2C9Dh			XXh
2C9Eh			XXh
2C9Fh			XXh
2CA0h	DTC Control Data 12	DTCD12	XXh
2CA0ff 2CA1h	DTC Control Data 12	DICDIZ	XXh
2CA2h			XXh
2CA3h			XXh
2CA4h			XXh
2CA5h			XXh
2CA6h			XXh
2CA7h			XXh
2CA8h	DTC Control Data 13	DTCD13	XXh
2CA9h	2 TO GOTTHIO DATE TO	2.02.0	XXh
2CAAh	-		XXh
2CABh			XXh
2CACh			XXh
2CADh			XXh
2CAEh			XXh
2CAFh			XXh
2CB0h	DTC Control Data 14	DTCD14	XXh
2CB1h			XXh
2CB2h	1		XXh
2CB3h			XXh
2CB4h	-		XXh
2CB5h			XXh
2CB6h			XXh
2CB7h			XXh
2CB8h	DTC Control Data 15	DTCD15	XXh
2CB9h			XXh
2CBAh			XXh
2CBBh			XXh
2CBCh	1		XXh
2CBDh	1		XXh
	-		
2CBEh			XXh
2CBFh			XXh
2CC0h	DTC Control Data 16	DTCD16	XXh
2CC1h			XXh
2CC2h			XXh
2CC3h			XXh
2CC4h	1		XXh
2CC5h	1		XXh
2CC6h	1		XXh
2CC7h	1		XXh
	DTC Control Data 47	DT0D47	
2CC8h	DTC Control Data 17	DTCD17	XXh
2CC9h			XXh
2CCAh			XXh
2CCBh			XXh
2CCCh			XXh
2CCDh	1		XXh
2CCEh	1		XXh
2CCFh	1		XXh
V. Undefined			AAH

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.12 SFR Information (12) (1)

Address	Register	Symbol	After Reset
2CD0h	DTC Control Data 18	DTCD18	XXh
2CD1h			XXh
2CD2h			XXh
2CD3h			XXh
2CD4h			XXh
2CD5h			XXh
2CD6h			XXh
2CD7h			XXh
2CD8h	DTC Control Data 19	DTCD19	XXh
2CD9h			XXh
2CDAh			XXh
2CDBh	†		XXh
2CDCh	†		XXh
2CDDh	1		XXh
2CDEh	1		XXh
2CDFh	1		XXh
2CE0h	DTC Control Data 20	DTCD20	XXh
2CE1h	5.5 55.1101 Bala 25	510520	XXh
2CE2h	-		XXh
2CE3h	-		XXh
2CE4h	-		XXh
2CE5h	-		XXh
2CE6h	-		XXh
2CE7h	-		XXh
2CE8h	DTC Control Data 21	DTCD21	XXh
2CE9h	DIC Control Data 21	DICDZI	XXh
2CEAh	-		XXh
2CEBh	-		XXh
2CECh	-		XXh
2CEDh	-		XXh
2CEEh	-		XXh
2CEFh	-		XXh
2CF0h	DTC Control Data 22	DTCD22	XXh
2CF0f1	DTC Control Data 22	DICDZZ	XXh
2CF1II	4		XXh
2CF2fi 2CF3h	-		XXh
2CF3fi 2CF4h	-		XXh
2CF4fi 2CF5h	-		XXh
2CF5fi 2CF6h	-		XXh
2CF6h	4		XXh
	DTC Control Data 22	DTCD22	
2CF8h	DTC Control Data 23	DTCD23	XXh
2CF9h	-		XXh
2CFAh	-		XXh
2CFBh	-		XXh
2CFCh	-		XXh
2CFDh	-		XXh
2CFEh	-		XXh
2CFFh			XXh
2D00h			
:			
2FFFh			

Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.13 ID Code Areas and Option Function Select Area

Address	Area Name	Symbol	After Reset
:			
FFDBh	Option Function Select Register 2	OFS2	(Note 1)
:	•	•	·
FFDFh	ID1		(Note 2)
:	•		·
FFE3h	ID2		(Note 2)
:			
FFEBh	ID3		(Note 2)
:			
FFEFh	ID4		(Note 2)
:			
FFF3h	ID5		(Note 2)
:			
FFF7h	ID6		(Note 2)
:		·	
FFFBh	ID7	·	(Note 2)
:		·	·
FFFFh	Option Function Select Register	OFS	(Note 1)

- 1. The option function select area is allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program.

 Do not write additions to the option function select area. If the block including the option function select area is erased, the option function select area is set to FFh.
 - When blank products are shipped, the option function select area is set to FFh. It is set to the written value after written by the user. When factory-programming products are shipped, the value of the option function select area is the value programmed by the user.
- 2. The ID code areas are allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program. Do not write additions to the ID code areas. If the block including the ID code areas is erased, the ID code areas are set to FFh. When blank products are shipped, the ID code areas are set to FFh. They are set to the written value after written by the user. When factory-programming products are shipped, the value of the ID code areas is the value programmed by the user.

R8C/33T Group 5. Electrical Characteristics

5. Electrical Characteristics

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vı	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	-40°C ≤ Topr ≤ 85°C	500	mW
Topr	Operating ambient temperature		-20 to 85 (N version)/ -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

Table 5.2 Recommended Operating Conditions

	Doromotor		0 1111	Standard					
Symbol		Pa	rameter		Conditions	Min.	Тур.	Max.	Unit
Vcc/AVcc	Supply voltage					1.8	_	5.5	V
Vss/AVss	Supply voltage					_	0	_	V
VIH	Input "H" voltage	Other th	nan CMOS ir	•		0.8 Vcc		Vcc	V
		CMOS		Input level selection		0.5 Vcc		Vcc	V
		input	switching	: 0.35 Vcc	$2.7~\textrm{V} \leq \textrm{Vcc} < 4.0~\textrm{V}$	0.55 Vcc		Vcc	V
			function (I/O port)		$1.8~\textrm{V} \leq \textrm{Vcc} < 2.7~\textrm{V}$	0.65 Vcc		Vcc	V
			(I/O port)	Input level selection	4.0 V ≤ Vcc ≤ 5.5 V	0.65 Vcc	_	Vcc	V
				: 0.5 Vcc	2.7 V ≤ Vcc < 4.0 V	0.7 Vcc	_	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.8 Vcc	_	Vcc	V
				Input level selection		0.85 Vcc	_	Vcc	V
				: 0.7 Vcc	2.7 V ≤ Vcc < 4.0 V	0.85 Vcc	_	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.85 Vcc	_	Vcc	V
			I clock input			1.2	_	Vcc	V
VIL	Input "L" voltage		nan CMOS ir			0	_	0.2 Vcc	V
		CMOS		Input level selection		0	_	0.2 Vcc	V
		input	switching function	: 0.35 Vcc	2.7 V ≤ Vcc < 4.0 V	0		0.2 Vcc	V
			(I/O port)		1.8 V ≤ Vcc < 2.7 V	0		0.2 Vcc	V
			(Input level selection		0		0.4 Vcc	V
				: 0.5 Vcc	2.7 V ≤ Vcc < 4.0 V	0		0.3 Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0		0.2 Vcc	V
				Input level selection : 0.7 Vcc		0		0.55 Vcc	V
					2.7 V ≤ Vcc < 4.0 V	0	_	0.45 Vcc	V
		_			1.8 V ≤ Vcc < 2.7 V	0		0.35 Vcc	V
	5		I clock input			0		0.4 Vcc	V
IOH(sum)	Peak sum output "H" current		all pins Iон(р	· 		_		-160	mA
IOH(sum)	Average sum output "H" current	Sum of	all pins Iон(а	avg)		_		-80	mA
IOH(peak)	Peak output "H"	Drive ca	apacity Low			_		-10	mA
	current	Drive ca	apacity High			_	_	-40	mA
IOH(avg)	Average output		apacity Low			_	_	-5	mA
	"H" current		apacity High			_	_	-20	mA
IOL(sum)	Peak sum output "L" current	Sum of	all pins lol(p	eak)		_	_	160	mA
IOL(sum)	Average sum output "L" current	Sum of	all pins IOL(a	vg)		_	_	80	mA
IOL(peak)	Peak output "L"	Drive ca	apacity Low			_	_	10	mA
	current	Drive ca	apacity High			_	_	40	mA
IOL(avg)	Average output	Drive ca	apacity Low			_	_	5	mA
	"L" current		apacity High			_		20	mA
f(XIN)	XIN clock input os	cillation fr	equency		2.7 V ≤ Vcc ≤ 5.5 V	_	_	20	MHz
					1.8 V ≤ Vcc < 2.7 V	_	_	5	MHz
fOCO40M	When used as the	count so	urce for time	er RC ⁽³⁾	2.7 V ≤ Vcc ≤ 5.5 V	32	_	40	MHz
fOCO-F	fOCO-F frequency				2.7 V ≤ Vcc ≤ 5.5 V	_	_	20	MHz
					1.8 V ≤ Vcc < 2.7 V	_		5	MHz
_	System clock frequ	iency			2.7 V ≤ Vcc ≤ 5.5 V	_		20	MHz
					1.8 V ≤ Vcc < 2.7 V	_	_	5	MHz
f(BCLK)	CPU clock frequer	су			2.7 V ≤ Vcc ≤ 5.5 V	_	_	20	MHz
					$1.8~V \leq Vcc < 2.7~V$	_	_	5	MHz

- 1. Vcc = 1.8 V to 5.5 V at Topr = -20°C to 85°C (N version)/-40°C to 85°C (D version), unless otherwise specified.
- 2. The average output current indicates the average value of current measured during 100 ms.
- 3. fOCO40M can be used as the count source for timer RC in the range of Vcc = 2.7 V to 5.5 V.

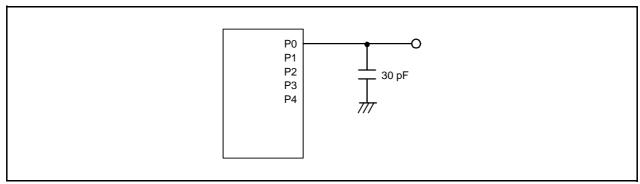


Figure 5.1 Ports P0 to P4 Timing Measurement Circuit

Table 5.3 A/D Converter Characteristics

Symbol	Parameter		Condi	itiono		Standard	l	Unit
Symbol	Faiametei		Condi	Conditions		Тур.	Max.	Offic
_	Resolution		Vref = AVcc		_	_	10	Bit
_	Absolute accuracy	10-bit mode	Vref = AVcc = 5.0 V	AN0 to AN7 input AN8 to AN11 input	_	_	±3	LSB
			Vref = AVcc = 3.3 V	AN0 to AN7 input AN8 to AN11 input	_	_	±5	LSB
			Vref = AVcc = 3.0 V	AN0 to AN7 input AN8 to AN11 input	_	_	±5	LSB
			Vref = AVcc = 2.2 V	AN0 to AN7 input AN8 to AN11 input	ı		±5	LSB
		8-bit mode	Vref = AVcc = 5.0 V	AN0 to AN7 input AN8 to AN11 input			±2	LSB
			Vref = AVcc = 3.3 V	AN0 to AN7 input AN8 to AN11 input	_	_	±2	LSB
			Vref = AVcc = 3.0 V	AN0 to AN7 input AN8 to AN11 input	_	_	±2	LSB
			Vref = AVcc = 2.2 V	AN0 to AN7 input AN8 to AN11 input	_	_	±2	LSB
φAD	A/D conversion clock		4.0 V ≤ Vref = AVcc ≤	5.5 V ⁽²⁾	2	_	20	MHz
			3.2 V ≤ Vref = AVcc ≤	5.5 V ⁽²⁾	2	_	16	MHz
			2.7 V ≤ Vref = AVcc ≤	5.5 V ⁽²⁾	2	_	10	MHz
			2.2 V ≤ Vref = AVcc ≤	5.5 V ⁽²⁾	2	_	5	MHz
_	Tolerance level impedance	Э			_	3	_	kΩ
tconv	Conversion time	10-bit mode	Vref = AVcc = 5.0 V, ¢	AD = 20 MHz	2.15	_	_	μS
		8-bit mode	Vref = AVcc = 5.0 V, ¢	AD = 20 MHz	2.15			ms
tsamp	Sampling time		φAD = 20 MHz		0.75	_	_	μS
IVref	Vref current		$Vcc = 5.0 \text{ V}, \text{ XIN} = \text{f1} = \phi \text{AD} = 20 \text{ MHz}$			45	_	μΑ
Vref	Reference voltage				2.2	_	AVcc	V
VIA	Analog input voltage (3)				0	_	Vref	V
OCVREF	On-chip reference voltage		2 MHz ≤ φAD ≤ 4 MH	Z	1.19	1.34	1.49	V

- 1. Vcc/AVcc = Vref = 2.2 V to 5.5 V, Vss = 0 V at Topr = -20 °C to 85 °C (N version)/-40 °C to 85 °C (D version), unless otherwise specified.
- 2. The A/D conversion result will be undefined in wait mode, stop mode, when the flash memory stops, and in low-consumption current mode. Do not perform A/D conversion in these states or transition to these states during A/D conversion.
- 3. When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.

Table 5.4 Flash Memory (Program ROM) Electrical Characteristics

Symbol	Parameter	Conditions		I India		
Symbol		Conditions	Min.	Тур.	Max.	Unit
_	Program/erase endurance (2)		1,000 (3)	_	_	times
_	Byte program time		_	80	500	μS
_	Block erase time		_	0.3	_	S
td(SR-SUS)	Time delay from suspend request until suspend		_	_	5 + CPU clock × 3 cycles	ms
_	Interval from erase start/restart until following suspend request		0	_	_	μS
_	Time from suspend until erase restart		_	_	30 + CPU clock × 1 cycle	μS
td(CMDRST -READY)	Time from when command is forcibly terminated until reading is enabled		_	_	30 + CPU clock × 1 cycle	μS
_	Program, erase voltage		2.7	_	5.5	V
_	Read voltage		1.8	_	5.5	V
_	Program, erase temperature		0	_	60	°C
_	Data hold time (7)	Ambient temperature = 55°C	20	_	_	year

Notes

- 1. Vcc = 2.7 V to 5.5 V at Topr = 0°C to 60°C, unless otherwise specified.
- 2. Definition of programming/erasure endurance

The programming and erasure endurance is defined on a per-block basis.

If the programming and erasure endurance is n (n = 1,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.

However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

- 3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
- 4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
- 5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 7. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.5 Flash Memory (Data flash Block A to Block D) Electrical Characteristics

Symbol	Parameter	Conditions		Unit		
Symbol	Faiametei	Conditions	Min.	Тур.	Max.	Offic
_	Program/erase endurance (2)		10,000 (3)	_	_	times
_	Byte program time (program/erase endurance ≤ 1,000 times)		_	160	1,500	μS
_	Byte program time (program/erase endurance > 1,000 times)		_	300	1,500	μS
_	Block erase time (program/erase endurance ≤ 1,000 times)		_	0.2	1	S
_	Block erase time (program/erase endurance > 1,000 times)		_	0.3	1	S
td(SR-SUS)	Time delay from suspend request until suspend		_	_	5 + CPU clock × 3 cycles	ms
_	Interval from erase start/restart until following suspend request		0	_	_	μS
_	Time from suspend until erase restart		_	_	30 + CPU clock × 1 cycle	μS
td(CMDRST -READY)	Time from when command is forcibly terminated until reading is enabled		_	_	30 + CPU clock × 1 cycle	μS
_	Program, erase voltage		2.7	_	5.5	V
_	Read voltage		1.8	_	5.5	V
_	Program, erase temperature		-20 ⁽⁷⁾	_	85	°C
_	Data hold time (8)	Ambient temperature = 55°C	20	_	_	year

- 1. Vcc = 2.7 V to 5.5 V at Topr = -20°C to 85°C (N version)/ -40°C to 85°C (D version), unless otherwise specified.
- 2. Definition of programming/erasure endurance
 - The programming and erasure endurance is defined on a per-block basis.
 - If the programming and erasure endurance is n (n = 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.
 - However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
- 3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
- 4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the erasure endurance between blocks A to D can further reduce the actual erasure endurance. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
- 5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 7. -40°C for D version.
- 8. The data hold time includes time that the power supply is off or the clock is not supplied.

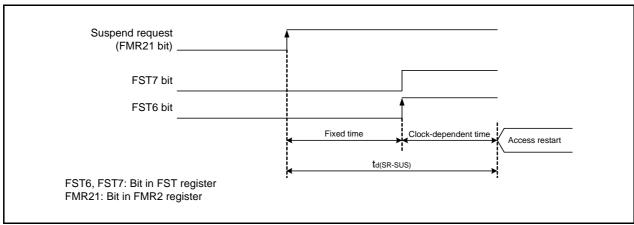


Figure 5.2 Time delay until Suspend

Table 5.6 Voltage Detection 0 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
			Min.	Тур.	Max.	Utill
Vdet0	Voltage detection level Vdet0_0 (2)		1.80	1.90	2.05	V
	Voltage detection level Vdet0_1 (2)		2.15	2.35	2.50	V
	Voltage detection level Vdet0_2 (2)		2.70	2.85	3.05	V
	Voltage detection level Vdet0_3 (2)		3.55	3.80	4.05	V
_	Voltage detection 0 circuit response time (4)	At the falling of Vcc from 5 V to (Vdet0_0 - 0.1) V	_	6	150	μS
_	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	_	1.5		μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts (3)		_	_	100	μS

Notes:

- 1. The measurement condition is Vcc = 1.8 V to 5.5 V and $Topr = -20 ^{\circ}\text{C}$ to $85 ^{\circ}\text{C}$ (N version)/ $-40 ^{\circ}\text{C}$ to $85 ^{\circ}\text{C}$ (D version).
- 2. Select the voltage detection level with bits VDSEL0 and VDSEL1 in the OFS register.
- 3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.
- 4. Time until the voltage monitor 0 reset is generated after the voltage passes V_{det0}.

Table 5.7 Voltage Detection 1 Circuit Electrical Characteristics

Cymphol	Parameter	Condition		Unit		
Symbol			Min.	Тур.	Max.	Unit
Vdet1	Voltage detection level Vdet1_0 (2)	At the falling of Vcc	2.00	2.20	2.40	V
	Voltage detection level Vdet1_1 (2)	At the falling of Vcc	2.15	2.35	2.55	V
	Voltage detection level Vdet1_2 (2)	At the falling of Vcc	2.30	2.50	2.70	V
	Voltage detection level Vdet1_3 (2)	At the falling of Vcc	2.45	2.65	2.85	V
	Voltage detection level Vdet1_4 (2)	At the falling of Vcc	2.60	2.80	3.00	V
	Voltage detection level Vdet1_5 (2)	At the falling of Vcc	2.75	2.95	3.15	V
	Voltage detection level Vdet1_6 (2)	At the falling of Vcc	2.85	3.10	3.40	V
	Voltage detection level Vdet1_7 (2)	At the falling of Vcc	3.00	3.25	3.55	V
	Voltage detection level Vdet1_8 (2)	At the falling of Vcc	3.15	3.40	3.70	V
	Voltage detection level Vdet1_9 (2)	At the falling of Vcc	3.30	3.55	3.85	V
	Voltage detection level Vdet1_A (2)	At the falling of Vcc	3.45	3.70	4.00	V
	Voltage detection level Vdet1_B (2)	At the falling of Vcc	3.60	3.85	4.15	V
	Voltage detection level Vdet1_C (2)	At the falling of Vcc	3.75	4.00	4.30	V
	Voltage detection level Vdet1_D (2)	At the falling of Vcc	3.90	4.15	4.45	V
	Voltage detection level Vdet1_E (2)	At the falling of Vcc	4.05	4.30	4.60	V
	Voltage detection level Vdet1_F (2)	At the falling of Vcc	4.20	4.45	4.75	V
_	Hysteresis width at the rising of Vcc in voltage	Vdet1_0 to Vdet1_5 selected		0.07		V
	detection 1 circuit	Vdet1_6 to Vdet1_F selected	_	0.10	_	V
_	Voltage detection 1 circuit response time (3)	At the falling of Vcc from 5 V to (Vdet1_0 – 0.1) V	_	60	150	μS
	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	_	1.7		μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽⁴⁾		_	_	100	μS

- 1. The measurement condition is Vcc = 1.8 V to 5.5 V and $Topr = -20 ^{\circ}\text{C}$ to $85 ^{\circ}\text{C}$ (N version)/ $-40 ^{\circ}\text{C}$ to $85 ^{\circ}\text{C}$ (D version).
- 2. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
- 3. Time until the voltage monitor 1 interrupt request is generated after the voltage passes V_{det1}.
- 4. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

R8C/33T Group 5. Electrical Characteristics

Table 5.8 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
			Min.	Тур.	Max.	Onit
Vdet2	Voltage detection level Vdet2_0	At the falling of Vcc	3.70	4.00	4.30	V
_	Hysteresis width at the rising of Vcc in voltage detection 2 circuit		_	0.10	_	V
_	Voltage detection 2 circuit response time (2)	At the falling of Vcc from 5 V to (Vdet2_0 - 0.1) V	_	20	150	μS
_	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	_	1.7	_	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		_	_	100	μS

Notes:

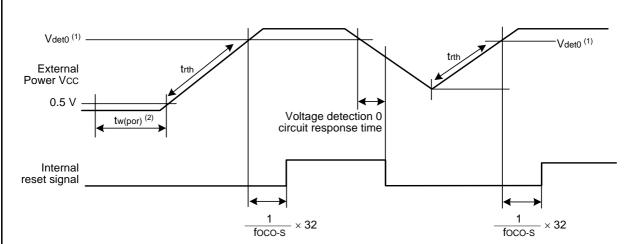
- 1. The measurement condition is Vcc = 1.8 V to 5.5 V and Topr = -20°C to 85°C (N version)/-40°C to 85°C (D version).
- 2. Time until the voltage monitor 2 interrupt request is generated after the voltage passes Vdet2.
- 3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.

Table 5.9 Power-on Reset Circuit (2)

	Symbol	Parameter	Condition	Standard			Unit
				Min.	Тур.	Max.	Offic
	trth	External power Vcc rise gradient	(Note 1)	0	_	50000	mV/msec

Notes:

- 1. The measurement condition is Topr = -20°C to 85°C (N version)/-40°C to 85°C (D version), unless otherwise specified.
- 2. To use the power-on reset function, enable voltage monitor 0 reset by setting the LVDAS bit in the OFS register to 0.



- Vdeto indicates the voltage detection level of the voltage detection 0 circuit. Refer to 6. Voltage Detection Circuit of Hardware Manual (REJ09B0544) for details.
- 2. tw(por) indicates the duration the external power Vcc must be held below the valid voltage (0.5 V) to enable a power-on reset. When turning on the power after it falls with voltage monitor 0 reset disabled, maintain tw(por) for 1 ms or more.

Figure 5.3 Power-on Reset Circuit Electrical Characteristics

R8C/33T Group 5. Electrical Characteristics

Table 5.10 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Unit		
Symbol			Min.	Тур.	Max.	Offic
_	High-speed on-chip oscillator frequency after reset	Vcc = 1.8 V to 5.5 V -20°C ≤ Topr ≤ 85°C	38.4	40	41.6	MHz
		Vcc = 1.8 V to 5.5 V -40°C ≤ Topr ≤ 85°C	38.0	40	42.0	MHz
	High-speed on-chip oscillator frequency when the FRA4 register correction value is written into the	Vcc = 1.8 V to 5.5 V -20°C ≤ Topr ≤ 85°C	35.389	36.864	38.338	MHz
	FRA1 register and the FRA5 register correction value into the FRA3 register (2)	Vcc = 1.8 V to 5.5 V -40°C ≤ Topr ≤ 85°C	35.020	36.864	38.707	MHz
	High-speed on-chip oscillator frequency when the FRA6 register correction value is written into the	Vcc = 1.8 V to 5.5 V -20°C ≤ Topr ≤ 85°C	30.72	32	33.28	MHz
	FRA1 register and the FRA7 register correction value into the FRA3 register	Vcc = 1.8 V to 5.5 V -40°C ≤ Topr ≤ 85°C	30.40	32	33.60	MHz
	Oscillation stability time	Vcc = 5.0 V, Topr = 25°C	_	0.5	3	ms
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	_	400	_	μΑ

Notes:

- 1. Vcc = 1.8 V to 5.5 V, Topr = -20 °C to 85 °C (N version)/-40 °C to 85 °C (D version), unless otherwise specified.
- 2. This enables the setting errors of bit rates such as 9600 bps and 38400 bps to be 0% when the serial interface is used in UART mode.

Table 5.11 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
			Min.	Тур.	Max.	Offic
fOCO-S	Low-speed on-chip oscillator frequency		60	125	250	kHz
_	Oscillation stability time	Vcc = 5.0 V, Topr = 25°C	_	30	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	_	2	_	μА

Note:

1. Vcc = 1.8 V to 5.5 V, Topr = -20 °C to 85 °C (N version)/-40 °C to 85 °C (D version), unless otherwise specified.

Table 5.12 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	Standard			Unit
Syllibol	Falametei	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during		_	_	2000	μS
	power-on (2)					

- 1. The measurement condition is Vcc = 1.8 V to 5.5 V and $Topr = 25^{\circ}C$.
- $2. \ \ \ Waiting time until the internal power supply generation circuit stabilizes during power-on.$

Table 5.13 Electrical Characteristics (1) [4.2 V \leq Vcc \leq 5.5 V]

Symbol	Parameter		Condition		Standard			Unit	
Symbol		raiaillelei	Condition		Min.	Тур.	Max.	Offic	
Vон	Output "H"	Other than XOUT	Drive capacity High Vcc = 5 V	Iон = −20 mA	Vcc - 2.0	_	Vcc	V	
	voltage		Drive capacity Low Vcc = 5 V	Iон = −5 mA	Vcc - 2.0	_	Vcc	V	
		XOUT	Vcc = 5 V	Іон = -200 μА	1.0	_	Vcc	V	
Vol	Output "L"	Other than XOUT	Drive capacity High Vcc = 5 V	IoL = 20 mA	_	_	2.0	V	
	voltage		Drive capacity Low Vcc = 5 V	IoL = 5 mA	_	_	2.0	V	
		XOUT	Vcc = 5 V	IOL = 200 μA	_	_	0.5	V	
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, KIO, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRCTRG, TRCCLK, ADTRG, RXD0, RXD1, RXD2, CLK0, CLK1, CLK2, SCL2, SDA2			0.1	1.2		V	
		RESET			0.1	1.2	_	V	
Iн	Input "H" current		VI = 5 V, Vcc = 5.0 V		_	_	5.0	μА	
lıL	Input "L" current		VI = 0 V, Vcc = 5.0 V		_	_	-5.0	μА	
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 5.0 V		25	50	100	kΩ	
RfXIN	Feedback resistance	XIN			_	0.3	_	ΜΩ	
VRAM	RAM hold v	oltage	During stop mode		1.8	_	_	V	

Note:

^{1. 4.2} V ≤ Vcc ≤ 5.5 V at Topr = -20°C to 85°C (N version)/-40°C to 85°C (D version), f(XIN) = 20 MHz, unless otherwise specified.

Table 5.14 Electrical Characteristics (2) [3.3 V \leq Vcc \leq 5.5 V] (Topr = -20° C to 85°C (N version)/ -40° C to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Condition		Standard			Unit	
•		Parameter Condition		Min. Typ.		Max.	Unit	
Icc	Power supply current (Vcc = 3.3 V to 5.5 V) Single-chip mode, output pins are open,	High-speed clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	6.5	15	mA	
	other pins are Vss		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	5.3	12.5	mA	
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	3.6	_	mA	
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3		mA	
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8		2.2	_	mA	
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8		1.5	_	mA	
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division		7	15	mA	
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8		3	_	mA	
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16 MSTTRD = MSTTRC = 1		1	_	mA	
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0		90	400	μА	
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	15	100	μА	
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	4	90	μА	
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	3.5	_	μА	
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off	_	2	5.0	μА	
			VCA27 = VCA26 = VCA25 = 0 XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off	_	5	_	μА	

Timing Requirements

(Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C)

Table 5.15 External Clock Input (XOUT)

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XOUT)	XOUT input cycle time	50	_	ns	
twh(xout)	XOUT input "H" width	24	_	ns	
tWL(XOUT)	XOUT input "L" width	24	_	ns	

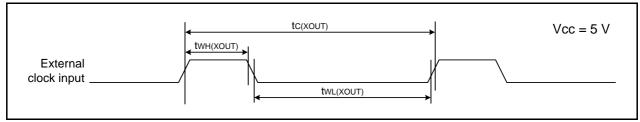


Figure 5.4 External Clock Input Timing Diagram when Vcc = 5 V

Table 5.16 TRAIO Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(TRAIO)	TRAIO input cycle time	100	_	ns	
twh(traio)	TRAIO input "H" width	40	_	ns	
tWL(TRAIO)	TRAIO input "L" width	40	_	ns	

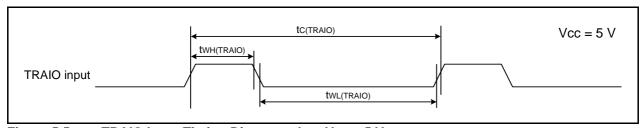


Figure 5.5 TRAIO Input Timing Diagram when Vcc = 5 V

Table 5.17 S	erial Interface
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Symbol	Parameter		Standard		
			Max.	Unit	
tc(CK)	CLKi input cycle time	200	_	ns	
tW(CKH)	CLKi input "H" width	100	_	ns	
tW(CKL)	CLKi input "L" width	100	_	ns	
td(C-Q)	TXDi output delay time	_	50	ns	
th(C-Q)	TXDi hold time	0	_	ns	
tsu(D-C)	RXDi input setup time	50	_	ns	
th(C-D)	RXDi input hold time	90	_	ns	

i = 0 to 2

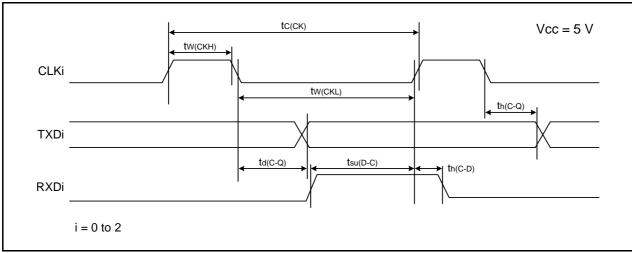


Figure 5.6 Serial Interface Timing Diagram when Vcc = 5 V

Table 5.18 External Interrupt INTi (i = 0 to 3) Input, Key Input Interrupt Kli (i = 0 to 3)

Symbol	Parameter		Standard		
Symbol			Max.	Unit	
tW(INH)	ĪNTi input "H" width, Kli input "H" width	250 ⁽¹⁾	_	ns	
tW(INL)	INTi input "L" width, Kli input "L" width	250 ⁽²⁾	_	ns	

Notes:

- 1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

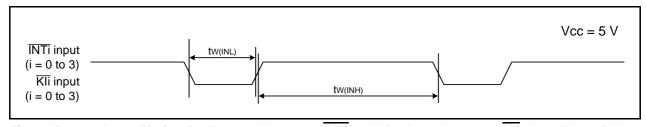


Figure 5.7 Input Timing for External Interrupt INTi and Key Input Interrupt Kli when Vcc = 5 V

Table 5.19 Electrical Characteristics (3) [2.7 V \leq Vcc < 4.2 V]

Symbol	Parameter		Condition			Unit		
Symbol		Falametei	Condition		Min.	Тур.	Max.	Offic
Vон	Output "H"	Other than XOUT	Drive capacity High	Iон = −5 mA	Vcc - 0.5	_	Vcc	V
	voltage		Drive capacity Low	Iон = −1 mA	Vcc - 0.5	_	Vcc	V
		XOUT		IOH = -200 μA	1.0	_	Vcc	V
Vol	Output "L"	Other than XOUT	Drive capacity High	IoL = 5 mA	_		0.5	V
	voltage		Drive capacity Low	IoL = 1 mA	_	_	0.5	V
		XOUT		IoL = 200 μA	_		0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, KIO, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRCTRG, TRCCLK, ADTRG, RXD0, RXD1, RXD2, CLK0, CLK1, CLK2, SCL2, SDA2	Vcc = 3.0 V		0.1	0.4	_	V
		RESET	Vcc = 3.0 V		0.1	0.5	_	V
lін	Input "H" current		$V_1 = 3 V, V_2 = 3.0 V$		_	_	4.0	μΑ
lıL	Input "L" current		$V_1 = 0 \text{ V}, \text{ Vcc} = 3.0 \text{ V}$		_	_	-4.0	μΑ
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 3.0 V		42	84	168	kΩ
RfXIN	Feedback resistance	XIN			_	0.3	_	ΜΩ
VRAM	RAM hold v	oltage	During stop mode		1.8	_	_	V

Note:

^{1. 2.7} V ≤ Vcc < 4.2 V at Topr = -20°C to 85°C (N version)/-40°C to 85°C (D version), f(XIN) = 10 MHz, unless otherwise specified.

Table 5.20 Electrical Characteristics (4) [2.7 V \leq Vcc < 3.3 V] (Topr = -20° C to 85 $^{\circ}$ C (N version)/ -40° C to 85 $^{\circ}$ C (D version), unless otherwise specified.)

	_				Standar	d	1.1-24
Symbol	Parameter	Parameter Condition		Min. Typ. Max			Unit
CC	Power supply current (Vcc = 2.7 V to 3.3 V) Single-chip mode, output pins are open,	High-speed clock mode	XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	3.5	10	mA
	other pins are Vss		XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.5	7.5	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	7	15	m/
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3		mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	4		mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.5		mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16 MSTTRD = MSTTRC = 1		1	_	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	_	90	390	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	15	90	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	4	80	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	3.5	_	μА
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0		2	5.0	μА
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	_	5	_	μА

Timing requirements

(Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = 25°C)

Table 5.21 External Clock Input (XOUT)

Symbol	Parameter		Standard		
			Max.	Unit	
tc(XOUT)	XOUT input cycle time	50	_	ns	
twh(xout)	XOUT input "H" width	24	_	ns	
twl(xout)	XOUT input "L" width	24	_	ns	

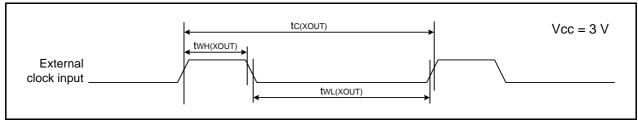


Figure 5.8 External Clock Input Timing Diagram when Vcc = 3 V

Table 5.22 TRAIO Input

Symbol	Parameter		Standard		
			Max.	Unit	
tc(TRAIO)	TRAIO input cycle time	300	_	ns	
twh(traio)	TRAIO input "H" width	120	_	ns	
tWL(TRAIO)	TRAIO input "L" width	120	_	ns	

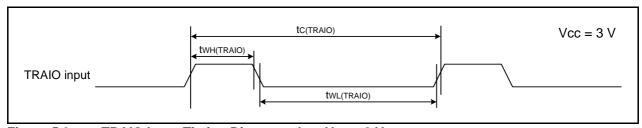


Figure 5.9 TRAIO Input Timing Diagram when Vcc = 3 V

Symbol	Parameter -		Standard		
Symbol			Max.	Unit	
tc(CK)	CLKi input cycle time	300	_	ns	
tW(CKH)	CLKi input "H" width		_	ns	
tW(CKL)	CLKi Input "L" width	150	_	ns	
td(C-Q)	TXDi output delay time	_	80	ns	
th(C-Q)	TXDi hold time		_	ns	
tsu(D-C)	RXDi input setup time		_	ns	
th(C-D)	RXDi input hold time		_	ns	

i = 0 to 2

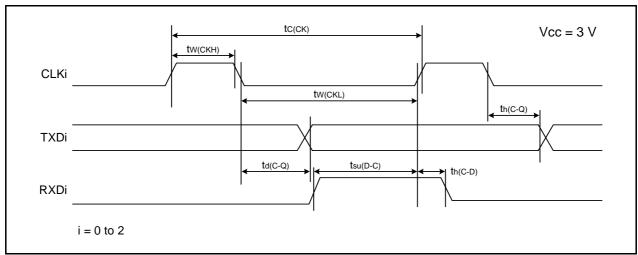


Figure 5.10 Serial Interface Timing Diagram when Vcc = 3 V

Table 5.24 External Interrupt $\overline{\text{INTi}}$ (i = 0 to 3) Input, Key Input Interrupt $\overline{\text{Kli}}$ (i = 0 to 3)

Symbol	Parameter	Standard		Unit	
Symbol	i didiletei		Max.		
tW(INH)	ĪNTi input "H" width, Kli input "H" width	380 (1)	_	ns	
tW(INL)	tw(INL) INTi input "L" width, KIi input "L" width		_	ns	

Notes:

- 1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

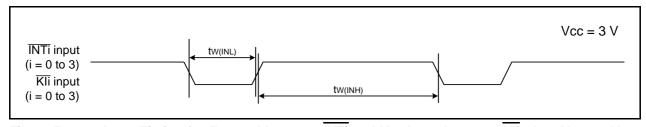


Figure 5.11 Input Timing for External Interrupt INTi and Key Input Interrupt Kli when Vcc = 3 V

Table 5.25 Electrical Characteristics (5) [1.8 $V \le Vcc < 2.7 V$]

Symbol	Parameter		Condition		Standard			Unit
Syllibol		Falametei	Condition		Min.	Тур.	Max.	Offic
Vон	Output "H"	Other than XOUT	Drive capacity High	lон = −2 mA	Vcc - 0.5	_	Vcc	V
	voltage		Drive capacity Low	Iон = −1 mA	Vcc - 0.5	_	Vcc	V
		XOUT		IOH = -200 μA	1.0	_	Vcc	V
Vol	Output "L"	Other than XOUT	Drive capacity High	IoL = 2 mA	_	_	0.5	V
	voltage		Drive capacity Low	IoL = 1 mA	_	_	0.5	V
		XOUT		IoL = 200 μA	_		0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, KIO, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRCTRG, TRCCLK, ADTRG, RXD0, RXD1, RXD2, CLK0, CLK1, CLK2, SCL2, SDA2			0.05	0.20	_	V
		RESET			0.05	0.20	_	V
lін	Input "H" cu	rrent	$V_I = 2.2 \text{ V}, \text{ Vcc} = 2.2 \text{ V}$		_	_	4.0	μΑ
lıL	Input "L" current		$V_1 = 0 V, V_2 = 2.2 V$		_	_	-4.0	μА
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 2.2 V		70	140	300	kΩ
RfXIN	Feedback resistance	XIN			_	0.3	_	ΜΩ
VRAM	RAM hold v	oltage	During stop mode		1.8	_	_	V

Note:

^{1. 1.8} V ≤ Vcc < 2.7 V at Topr = -20°C to 85°C (N version)/-40°C to 85°C (D version), f(XIN) = 5 MHz, unless otherwise specified.

Table 5.26 Electrical Characteristics (6) [1.8 V \leq Vcc < 2.7 V] (Topr = -20° C to 85°C (N version)/ -40° C to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Condition	;	Standar	d	Unit
Symbol			Condition	Min.	Тур.	Max.	Offic
Icc	Power supply current (Vcc = 1.8 V to 2.7 V) Single-chip mode, output pins are open,	High-speed clock mode	XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	2.2	_	mA
	other pins are Vss		XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8		0.8	_	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 5 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	2.5	10	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 5 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.7	_	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16 MSTTRD = MSTTRC = 1	_	1	_	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	_	90	300	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	15	90	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	4	80	μΑ
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	_	3.5	_	μА
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	_	2	5	μА
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0		5	_	μА

Timing requirements

(Unless Otherwise Specified: Vcc = 2.2 V, Vss = 0 V at Topr = 25°C)

Table 5.27 External Clock Input (XOUT)

Symbol	Parameter	Stan	dard	Unit	
Symbol	Falametei		Max.	Offic	
tc(XOUT)	XOUT input cycle time	200	_	ns	
tWH(XOUT)	XOUT input "H" width	90	_	ns	
twl(xout)	XOUT input "L" width	90	_	ns	

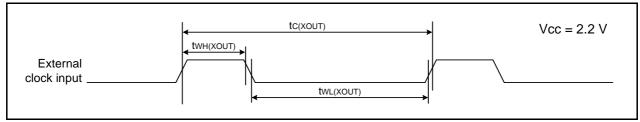


Figure 5.12 External Clock Input Timing Diagram when Vcc = 2.2 V

Table 5.28 TRAIO Input

Symbol	Parameter	Standard		Unit	
Symbol	Falametei		Max.		
tc(TRAIO)	TRAIO input cycle time	500	_	ns	
twh(traio)	TRAIO input "H" width		_	ns	
tWL(TRAIO)	TRAIO input "L" width	200	_	ns	

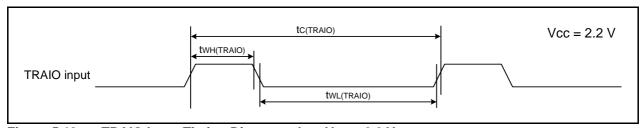


Figure 5.13 TRAIO Input Timing Diagram when Vcc = 2.2 V

Table	5.29	Serial Interface
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Symbol	Parameter		Standard		
Symbol	Farameter	Min.	Max.	Unit	
tc(CK)	CLKi input cycle time		_	ns	
tW(CKH)	CLKi input "H" width		_	ns	
tW(CKL)	CLKi input "L" width		_	ns	
td(C-Q)	TXDi output delay time	_	200	ns	
th(C-Q)	TXDi hold time		_	ns	
tsu(D-C)	RXDi input setup time		_	ns	
th(C-D)	RXDi input hold time	90	_	ns	

i = 0 to 2

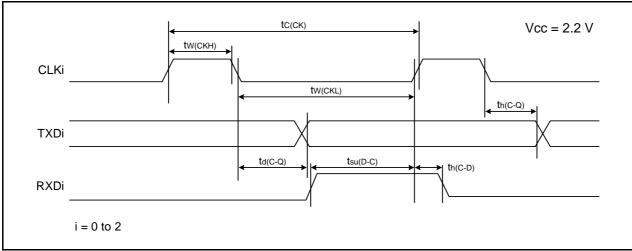


Figure 5.14 Serial Interface Timing Diagram when Vcc = 2.2 V

Table 5.30 External Interrupt INTi (i = 0 to 3) Input, Key Input Interrupt Kli (i = 0 to 3)

Symbol	Parameter	Standard		Unit
Symbol	Faidilletei	Min.	Max.	Offic
tW(INH)	ĪNTi input "H" width, Kli input "H" width		-	ns
tW(INL)	ĪNTi input "L" width, Kli input "L" width		-	ns

Notes:

- 1. When selecting the digital filter by the $\overline{\text{INTi}}$ input filter select bit, use an $\overline{\text{INTi}}$ input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

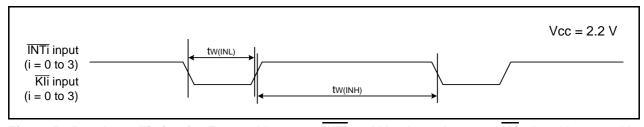
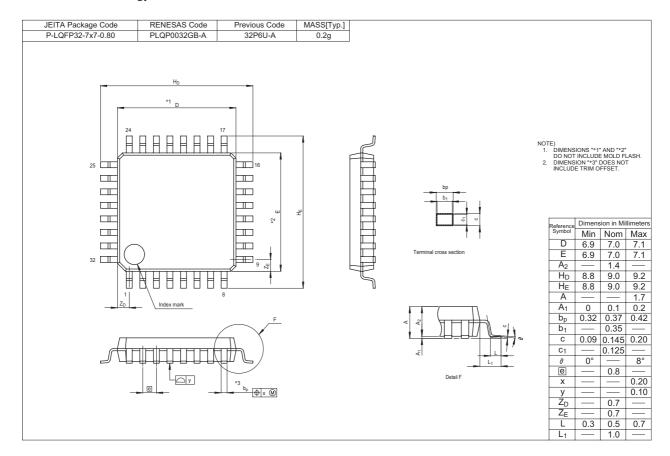


Figure 5.15 Input Timing for External Interrupt INTi and Key Input Interrupt Kli when Vcc = 2.2 V

R8C/33T Group Package Dimensions

Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Technology website.



REVISION HISTORY	R8C/33T Group Datasheet
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Rev.	Date	Description			
INEV.	Date	Page	Summary		
1.00	Mar 16, 2010	_	First Edition issued		

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